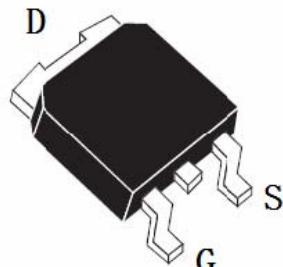


## P-Channel Enhancement Mode Field Effect Transistor

- Features

$V_{DS}$	$R_{DS(ON)MAX}$	$I_D$
-30V	75 m $\Omega$ @-10V	-6A
	80 m $\Omega$ @-4.5V	

- Pin Configurations



- General Description

The HG6P30TA uses advanced trench technology to provide excellent  $R_{DS(ON)}$  with low gate charge. This device is suitable for use as a load switch or in PWM applications.

- Absolute Maximum Ratings @  $T_A=25^\circ C$  unless otherwise noted

Parameter		Symbol	Ratings	Unit
Drain-Source Voltage		$V_{DSS}$	-30	V
Gate-Source Voltage		$V_{GSS}$	$\pm 20$	V
Drain Current (Continuous) *AC	$T_A=25^\circ C$	$I_D$	-6	A
	$T_A=70^\circ C$		-4.8	
Drain Current (Pulse) *B		$I_{DM}$	-30	A
Power Dissipation	$T_A=25^\circ C$	$P_D$	50	W
	$T_A=70^\circ C$		25	
Operating Temperature/ Storage Temperature		$T_J/T_{STG}$	-55~150	°C

## Electrical Characteristics

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$T_A=25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = -250\mu\text{A}$	-30	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = -30\text{ V}, V_{GS} = 0\text{V}$	--	--	-1	$\mu\text{A}$
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{GS} = V_{DS}, I_{DS} = -250\mu\text{A}$	-1	-1.4	-3	V
Gate Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$	--	--	100	nA
Drain-Source On-state Resistance	$R_{DS(\text{on})}$	$V_{GS} = -10\text{V}, I_D = -6\text{A}$	--	55	75	$\text{m}\Omega$
		$V_{GS} = -4.5\text{V}, I_D = -3\text{A}$	--	68	80	$\text{m}\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = -10\text{V}, I_D = -5.3\text{A}$	--	10	--	S
Diode Forward Voltage	$V_{SD}$	$I_{SD} = -1.7\text{A}, V_{GS} = 0\text{V}$	--	-0.82	-1.2	V
<b>Switching</b>						
Total Gate Charge	$Q_g$	$V_{GS} = -10\text{V}, V_{DS} = -15\text{V}, I_D = -5.3\text{A}$	--	28	36.4	nC
Gate-Source Charge	$Q_{gs}$		--	3	3.9	nC
Gate-Drain Charge	$Q_{gd}$		--	7	9.1	nC
Turn-on Delay Time	$t_{d(on)}$	$V_{GS} = -10\text{V}, V_{DS} = -15\text{V}, R_L = 15\Omega, R_{GEN} = 6\Omega$	--	9	18	ns
Turn-on Rise Time	$t_r$		--	15	30	ns
Turn-off Delay Time	$t_{d(off)}$		--	75	150	ns
Turn-off Fall Time	$t_f$		--	40	80	ns
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = -15\text{V}, f = 1\text{MHz}$	--	745	--	pF
Output Capacitance	$C_{oss}$		--	440	--	pF
Reverse Transfer Capacitance	$C_{rss}$		--	120	--	pF

A: The value of  $R_{iJA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C: The current rating is based on the  $t \leq 10\text{s}$  junction to ambient thermal resistance rating.

# Typical Electrical and Thermal Characteristics

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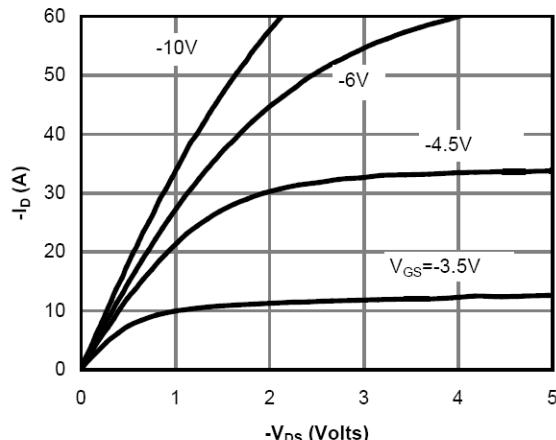


Figure 1: On-Region Characteristics

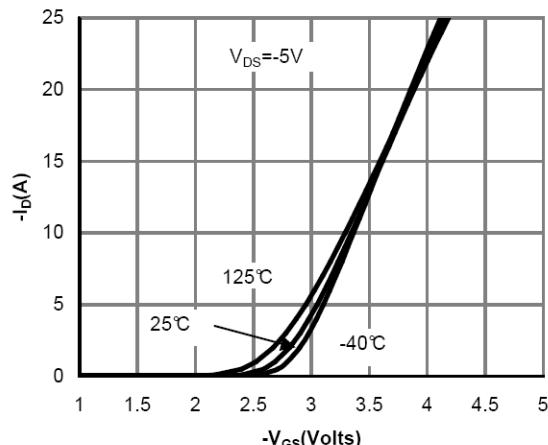


Figure 2: Transfer Characteristics

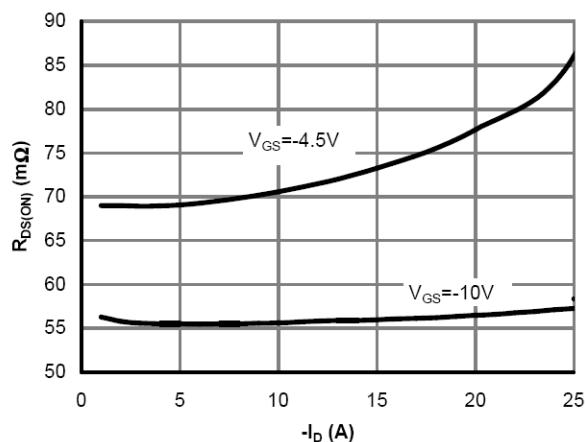


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

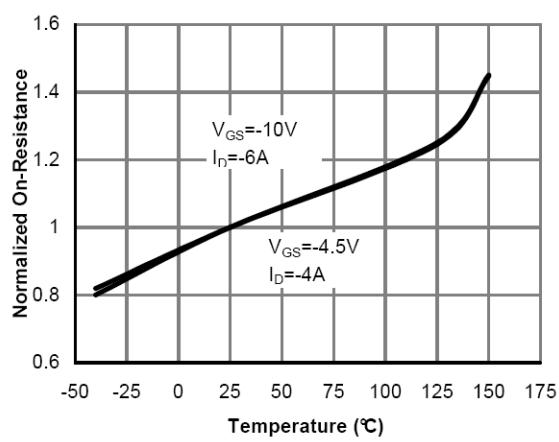


Figure 4: On-Resistance vs. Junction Temperature

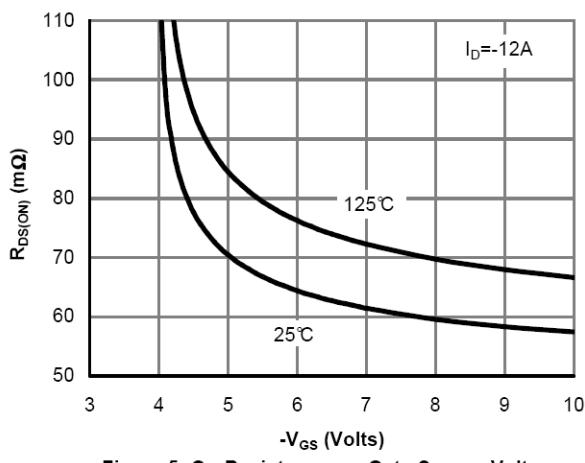


Figure 5: On-Resistance vs. Gate-Source Voltage

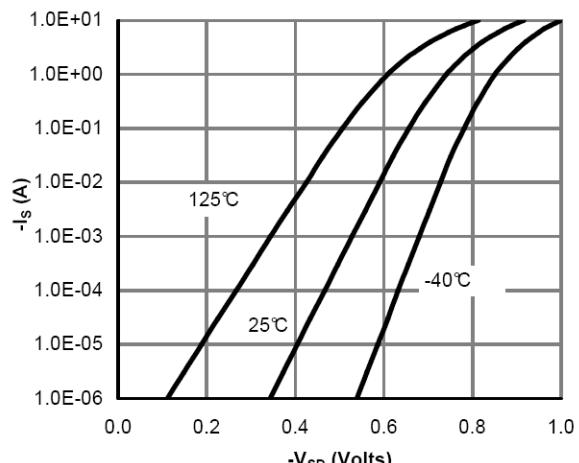
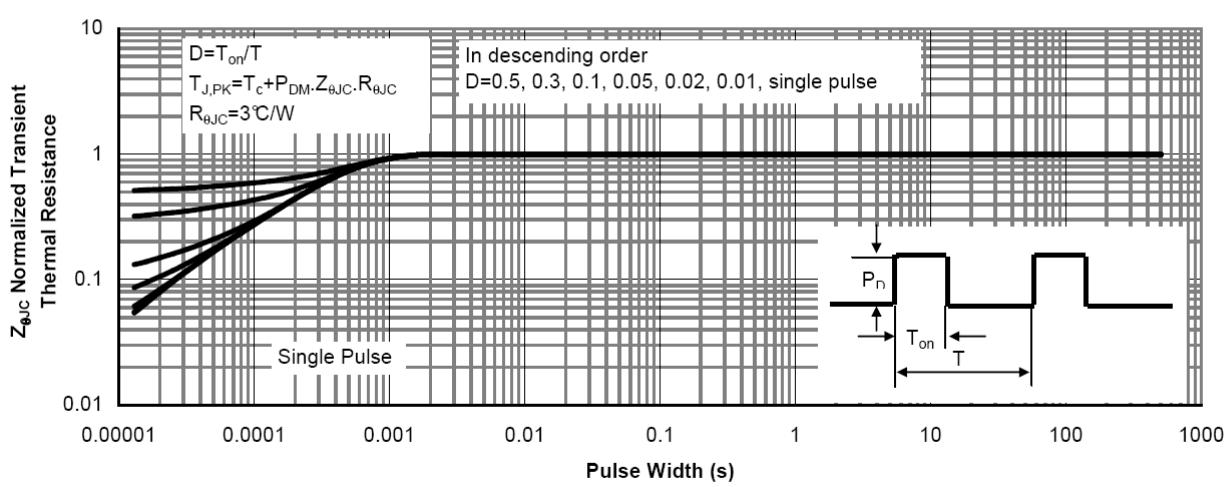
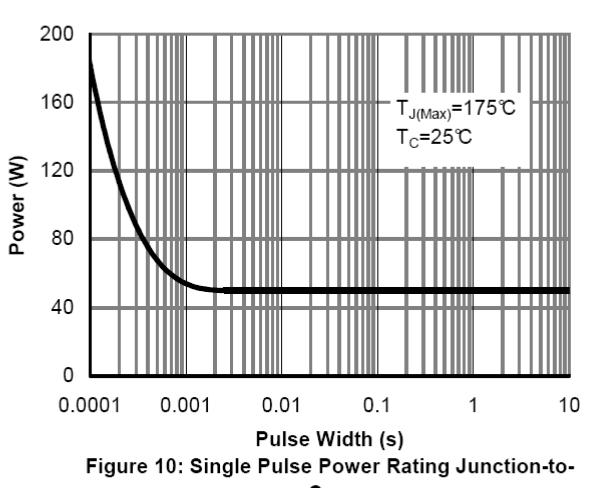
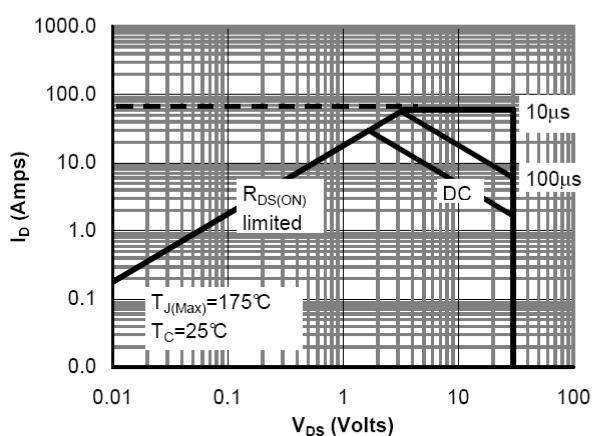
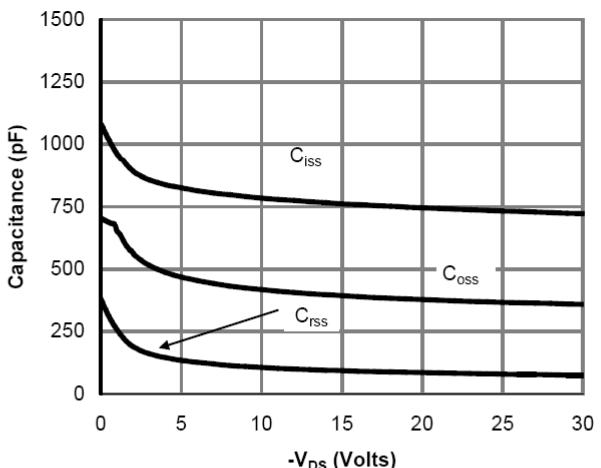
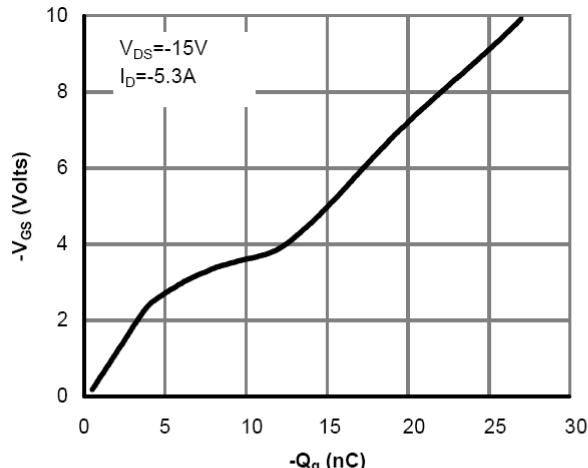


Figure 6: Body-Diode Characteristics

## Typical Electrical and Thermal Characteristics



## Package Information

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